



**THE DATASHEET OF
STTS3000B2DN3F**

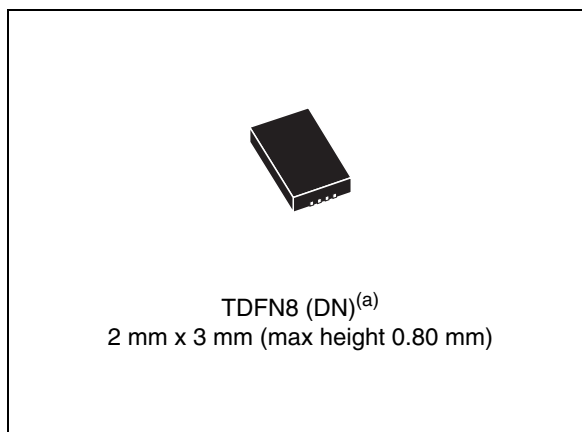


2.3 V memory module temperature sensor

Data brief

Features

- STTS3000 is a 2.3 V memory module temperature sensor forward compatible with JEDEC standard TS3000 and backward compatible with STTS424
- Operating temperature range:
 - -40 °C to +125 °C
- Single supply voltage: 2.3 V to 3.6 V
- Temperature sensor resolution: programmable (9-12 bits)
0.25 °C (typ)/LSB - (10-bit) default
- Temperature sensor accuracy (max):
 - ± 1 °C from +75 °C to +95 °C
 - ± 2 °C from +40 °C to +125 °C
 - ± 3 °C from -40 °C to +125 °C
- ADC conversion time: 125 ms (max) at default resolution (10-bit)
- Typical operating supply current: 160 µA
- Temperature hysteresis selectable set points from: 0, 1.5, 3, 6.0 °C
- Two-wire SMBus/I²C - compatible serial interface
- Supports up to 400 kHz transfer rate
- Does not initiate clock stretching
- Supports SMBus timeout 25 ms - 35 ms
- Spike suppression filters on the two-wire bus inputs
- Voltage hysteresis per I²C specs on the two-wire bus inputs



- 2 mm x 3 mm TDFN8, height: 0.80 mm (max)^(a)
- RoHS compliant, halogen-free

a. Compliant to JEDEC MO-229, WCED-3

1 Description

The STTS3000 is targeted for DIMM modules in mobile personal computing platforms (laptops), servers and other industrial applications. The thermal sensor (TS) in the STTS3000 is compliant with the JEDEC specification TS3000 which defines memory module thermal sensors requirements for mobile platforms.

The TS provides space as well as cost savings for mobile and server platform dual inline memory modules (DIMM) manufacturers, as it is packaged in the compact 2 mm x 3 mm 8-lead TDFN package with a thinner maximum height of 0.80 mm. The DN package is compliant to JEDEC MO-229, variation WCED-3.

The digital temperature sensor has a programmable 9-12 bit analog-to-digital converter (ADC) which monitors and digitizes the temperature to a resolution of up to 0.0625 °C. The default resolution is 0.25 °C/LSB (10-bit). The typical accuracies over these temperature ranges are:

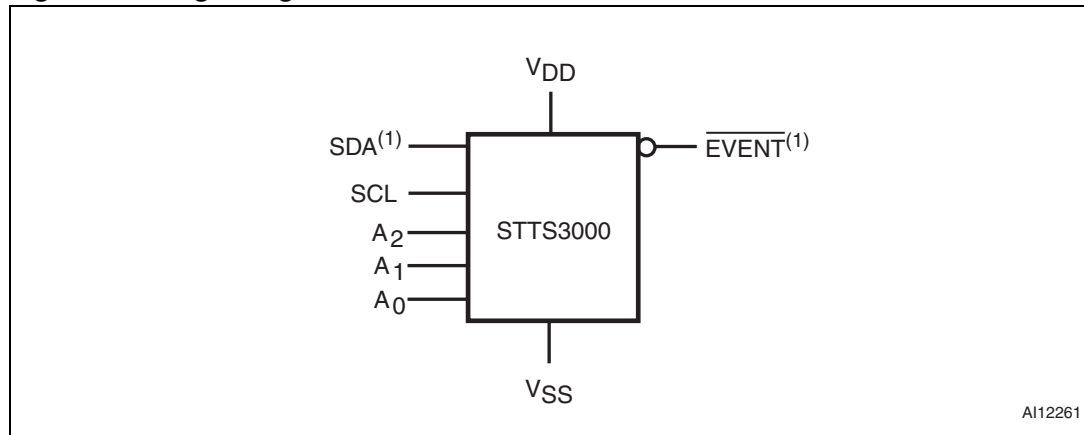
- ± 2 °C over the full temperature measurement range of -40 °C to 125 °C
- ± 1 °C in the $+40$ °C to $+125$ °C active temperature range, and
- ± 0.5 °C in the $+75$ °C to $+95$ °C monitor temperature range

The temperature sensor in the STTS3000 is specified for operating at supply voltages from 2.3 V to 3.6 V. Operating at 3.3 V, the typical supply current is 160 μ A (includes SMBus communication current).

The on-board sigma delta ADC converts the measured temperature to a digital value that is calibrated in °C. For Fahrenheit applications, a lookup table or conversion routine is required. The STTS3000 is factory-calibrated and requires no external components to measure temperature.

The digital temperature sensor has user-programmable registers that provide the capabilities for DIMM temperature-sensing applications. The open drain event output pin is active when the monitoring temperature exceeds a programmable limit, or it falls above or below an alarm window. The user has the option to set the event output as a critical temperature output. This pin can be configured to operate in either a comparator mode for thermostat operation or in interrupt mode.

Figure 1. Logic diagram



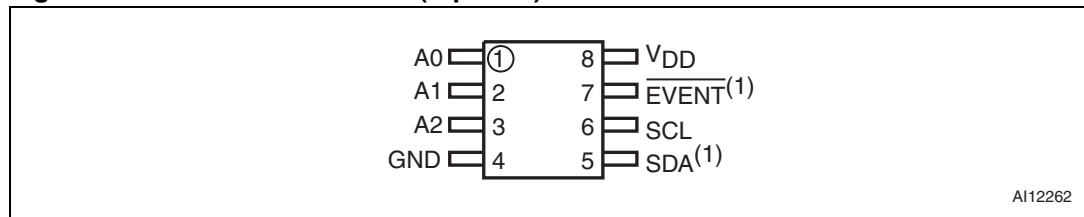
1. SDA and $\overline{\text{EVENT}}$ are open drain.

Table 1. Signal names

Pin	Symbol	Description	Type
1	A0	Serial bus address selection pin. Can be tied to V_{SS} or V_{DD} .	Input
2	A1	Serial bus address selection pin. Can be tied to V_{SS} or V_{DD} .	Input
3	A2	Serial bus address selection pin. Can be tied to V_{SS} or V_{DD} .	Input
4	V_{SS}	Supply ground	
5	$\text{SDA}^{(1)}$	Serial data	Input/output
6	SCL	Serial clock	Input
7	$\overline{\text{EVENT}}^{(1)}$	Event output pin. Open drain and active-low.	Output
8	V_{DD}	Supply power (2.3 V to 3.6 V)	

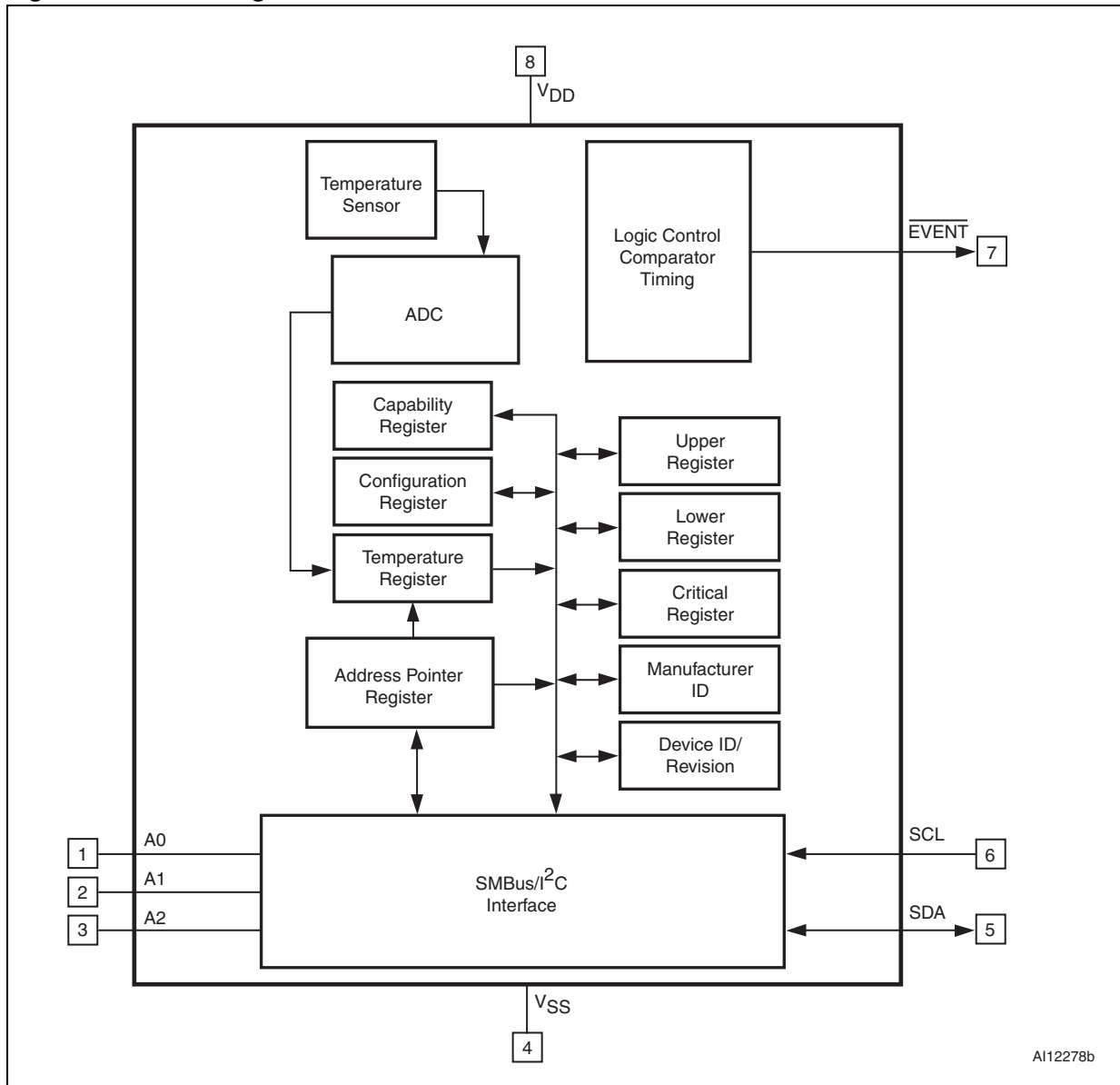
1. SDA and $\overline{\text{EVENT}}$ are open drain.

Figure 2. TDFN8 connections (top view)



1. SDA and $\overline{\text{EVENT}}$ are open drain.

Figure 3. Block diagram



2 Temperature sensor registers

The temperature sensor component is comprised of various user-programmable registers. These registers are required to write their corresponding addresses to the pointer register. They can be accessed by writing to their respective addresses (see [Table 2](#)). Pointer register bits 7 - 4 must always be written to '0'. This must be maintained, as not setting these bits to '0' may keep the device from performing to specifications.

The main registers include:

- Capability register (read-only)
- Configuration register (read/write)
- Temperature register (read-only)
- Alarm temperature trip registers (read/write), including
 - Alarm temperature upper boundary,
 - Alarm temperature lower boundary, and
 - Critical temperature.
- Manufacturer's ID register (read-only)
- Device ID and device revision ID register (read-only)
- Temperature resolution register (TRES) (read/write)

Table 2. Temperature sensor registers summary

Address (hex)	Register name		Power-on default
Not applicable	Address pointer		Undefined
00	Capability	B-grade only	0x006F
01	Configuration		0x0000
02	Alarm temperature upper boundary trip		0x0000
03	Alarm temperature lower boundary trip		0x0000
04	Critical temperature trip		0x0000
05	Temperature		Undefined
06	Manufacturer's ID		0x104A
07	Device ID/revision		0x0200
08	Temperature resolution register		0x01

Note: Registers beyond the specified (00-08) are reserved for STMicroelectronics internal use only, for device test modes in product manufacturing. The registers must NOT be accessed by the user (customer) in the system application or the device may not perform according to specifications.

3 Part numbering

Table 3. Ordering information scheme

Example:	STTS3000	B	2	DN	3	F
Device type						
STTS3000						
Accuracy grade						
B: Maximum accuracy 75 °C to 95 °C = ± 1 °C						
Voltage (minimum)						
2 = 2.3 V - 3.6 V part						
Package						
DN = TDFN8 (0.80 mm max height)						
Temperature						
3 = -40 °C to 125 °C						
Shipping method						
F = ECOPACK® package, tape & reel packing						
E = ECOPACK® package, tube packing						

For other options, or for more information on any aspect of this device, please contact the ST sales office nearest you.

4 Revision history

Table 4. Document revision history

Date	Revision	Changes
19-Apr-2010	1	Initial release.

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